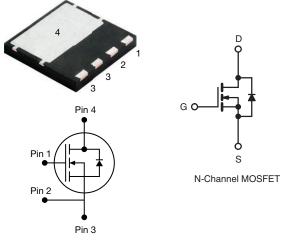




## **E Series Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.220				
Q <sub>g</sub> max. (nC)	82					
Q <sub>gs</sub> (nC)	8					
Q <sub>gd</sub> (nC)	16					
Configuration	Single					

### PowerPAK<sup>®</sup> 8 x 8



## FEATURES

- Fully lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH14N60E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V <sub>DS</sub>	600	V		
Gate-Source Voltage		V <sub>GS</sub>	± 30	V		
Continuous Drain Current (T, = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I <sub>D</sub>	16			
Continuous Drain Current $(I_J = 150 \text{ C})$	$T_{\rm C} = 100 ^{\circ}{\rm C}$		10	А		
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	38	]		
Linear Derating Factor			1.2	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	173	mJ			
Maximum Power Dissipation	PD	147	W			
Operating Junction and Storage Temperature Ran	ge	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	70	- V/ns		
Reverse Diode dV/dt <sup>c</sup>			19	v/ns		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.5 A.

c.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.



COMPLIANT



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	42		55 0.85				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.64				°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	1	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static		1			1			L
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	2.0	-	4.0	V
	•	١	$I_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	\	$I_{GS} = \pm 30$	V	-	-	± 1	μA
		V <sub>DS</sub> =	600 V, V <sub>G</sub>	s = 0 V	-	-	1	
Forward Transconductance	I <sub>DSS</sub>	-	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	50	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		<sub>D</sub> = 7 A	-	0.220	0.255	Ω
Forward Transconductance	9 <sub>fs</sub>		= 30 V, I <sub>D</sub>	= 7 A	-	5.8	-	S
Dynamic					•	1		
Input Capacitance	C <sub>iss</sub>		$V_{ee} = 0.V$		-	1416	-	
Output Capacitance	C <sub>oss</sub>	- ·	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	74	-	1
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	6	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	67	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	232	-	1	
Total Gate Charge	Qg				-	41	82	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7 A	A, V <sub>DS</sub> = 480 V	-	8	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	16	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	16	32	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 480 V, I <sub>D</sub>	= 7 A,	-	21	42	
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	10 V, R <sub>g</sub> =	= 9.1 Ω	-	56	84	ns
Fall Time	t <sub>f</sub>				-	31	62	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.2	0.75	1.6	Ω	
Drain-Source Body Diode Characteristic					•	•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	16	^	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	38	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 7 A,	$V_{GS} = 0 V$	-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			7.4	-	288	576	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 7 A, dl/dt = 100 A/μs, V <sub>B</sub> = 25 V		-	3.5	7.0	μC	
Reverse Recovery Current	I <sub>RRM</sub>		,μο, ι	K - 20 V	-	22	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

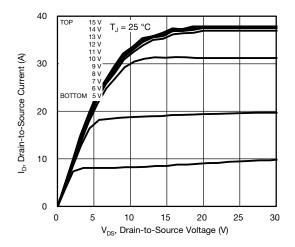
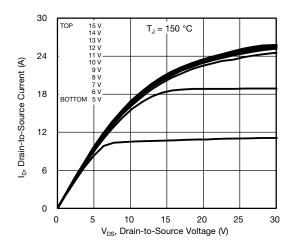
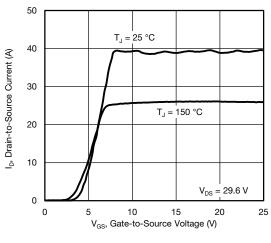


Fig. 1 - Typical Output Characteristics









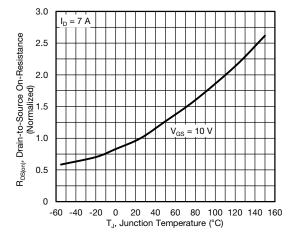


Fig. 4 - Normalized On-Resistance vs. Temperature

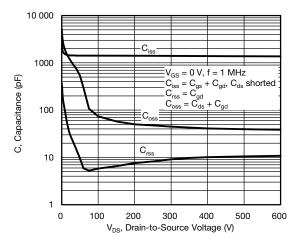
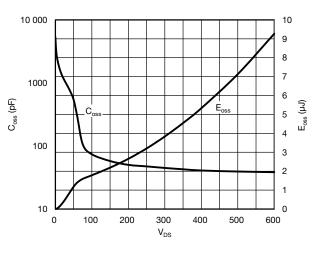


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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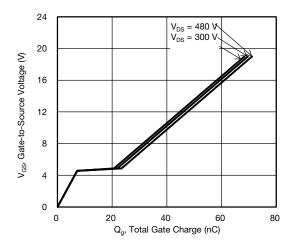


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

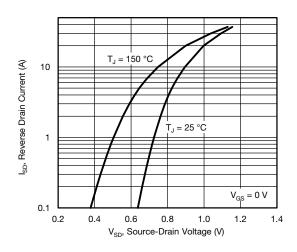


Fig. 8 - Typical Source-Drain Diode Forward Voltage

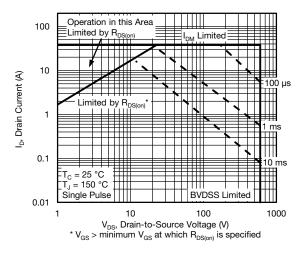


Fig. 9 - Maximum Safe Operating Area

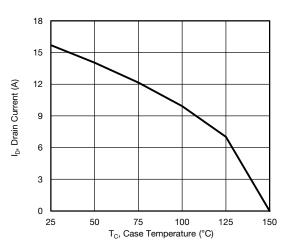


Fig. 10 - Maximum Drain Current vs. Case Temperature

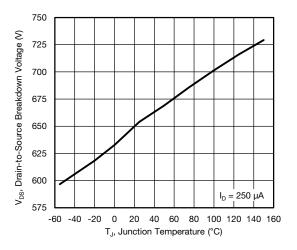
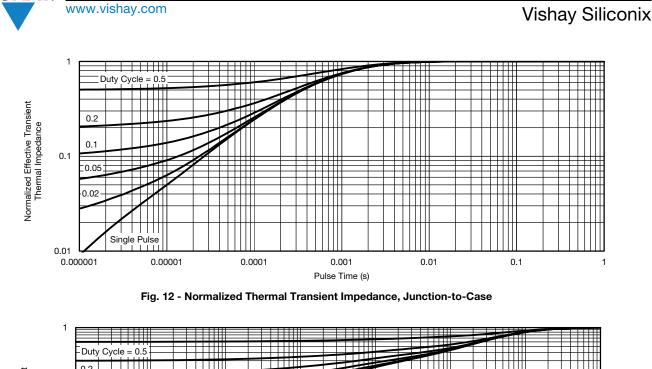


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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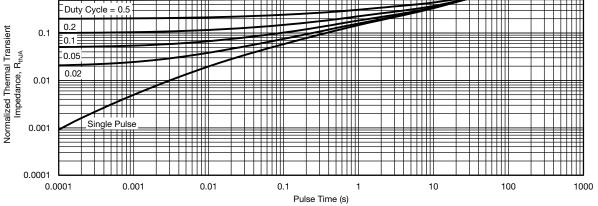


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

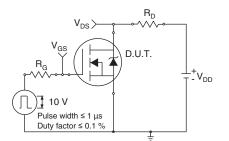


Fig. 14 - Switching Time Test Circuit

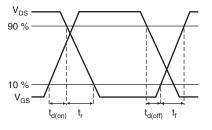


Fig. 15 - Switching Time Waveforms

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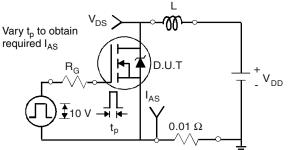
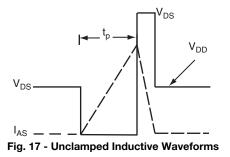


Fig. 16 - Unclamped Inductive Test Circuit

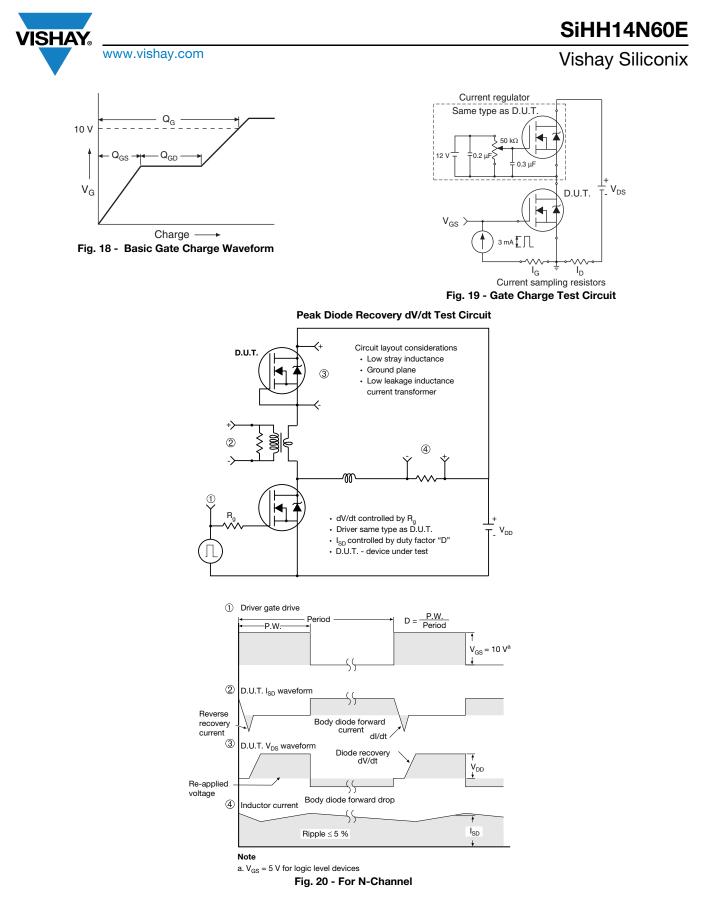


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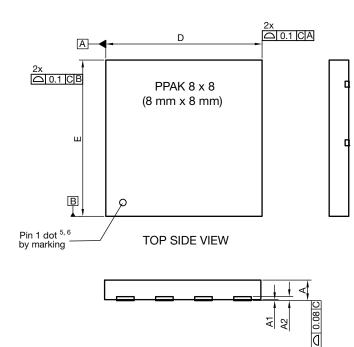
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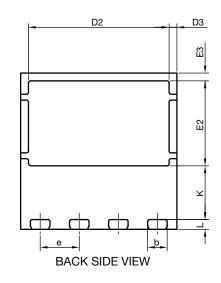
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM.		MILLIMETERS			INCHES	
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2		020 ref.			0.008 ref.	
b	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3		0.40 BSC		0.016 BSC		
е		2.00 BSC			0.079 BSC	
E	7.90	8.00	8.10	0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC			0.016 BSC		
К		2.75 BSC		0.108 BSC		
L	0.45	0.50	0.55	0.018	0.020	0.022
N <sup>(3)</sup>		8		8		

#### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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